

GF1A - GF1M

Features

- Low forward voltage drop.
- High current capability.
- Easy pick and place.
- High surge current capability.



SMA/DO-214AC COLOR BAND DENOTES CATHODE

1.0 Ampere Glass Passivated Rectifier

Absolute Maximum Ratings*

 $T_{\Delta} = 25^{\circ}$ C unless otherwise noted

Symbol	Parameter	Value	Units	
I _{F(AV)}	Average Rectified Current	1.0	Α	
	@ T _L = 125°C			
I _{FSM}	Non-repetitive Peak Forward Surge Current			
	8.3 ms single half-sine-wave	30	Α	
	Superimposed on rated load (JEDEC method)			
P_D	Total Device Dissipation	2.0	W	
	Derate above 25°C	13	mW/°C	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient **	80	°C/W	
$R_{\theta JC}$	Thermal Resistance, Junction to Case **	26	°C/W	
T _{stg}	Storage Temperature Range	-65 to +175	°C	
TJ	Operating Junction Temperature	-65 to +175	°C	

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Electrical Characteristics T_A = 25°C unless otherwise noted

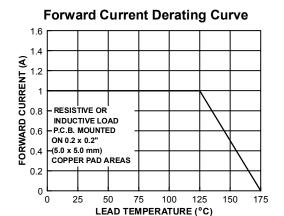
Symbol	Symbol Parameter				Device						
		1A	1B	1D	1G	1J	1K	1M			
V_{RRM}	Maximum Repetitive Reverse Voltage	50	100	200	400	600	800	100 0	V		
V _{RMS}	Maximum RMS Voltage	35	70	140	280	420	560	800	V		
V_R	DC Reverse Voltage (Rated V _R)	50	100	200	400	600	800	100 0	V		
I _{RM}	Maximum Instantaneous Reverse Current @ rated V_R $T_A = 25^{\circ}C$ $T_A = 125^{\circ}C$	5.0 50						μ Α μ Α			
V_{FM}	Maximum Instantaneous Forward Voltage @ 1.0 A	1.0 1.2						V			
t _{rr}	Maximum Reverse Recovery Time $I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$	2.0						μs			
С	Typical Junction Capacitance V _R = 4.0 V, f = 1.0 MHz	15					pF				

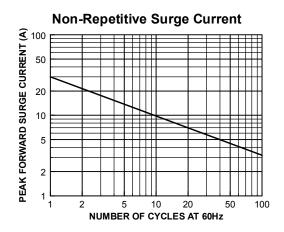
^{**} Device mounted on PCB with 0.2 x 0.2" (5.0 x 5.0 mm) copper pad areas.

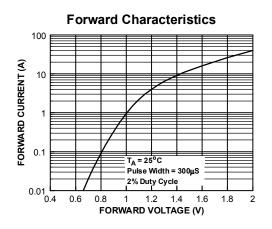
Surface Mount Glass Passivated Rectifier

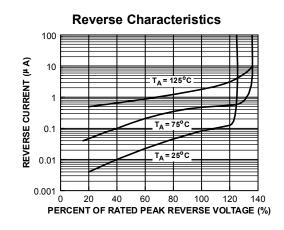
(continued)

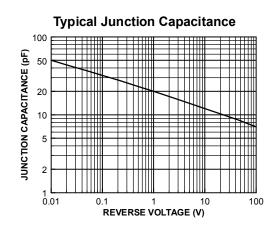
Typical Characteristics







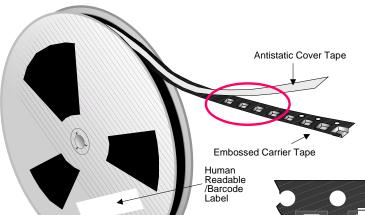




DO-214AC(SMA) Tape and Reel Data



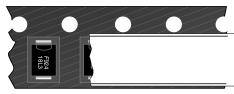
DO-214AC(SMA) Packaging Configuration: Figure 1.0



Packaging Description:

DO-214AC(SMA) parts are shipped in tape. The carrier DO-214AC(SMA) parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. Alternate carrier tape is made of antistatic plastic. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reled parts in standard option are shipped with 7,500 units per 13° or 330cm diameter reel. The reel comes in plastic or carton which is made of polystyrene plastic (anti-static coated) and thick white paper respectively. Further information is described in the Packacing information table. Packaging Information table.

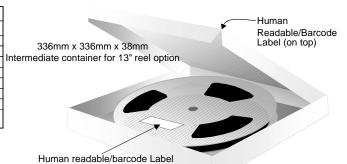
These full reels are individually labeled and placed inside a bleach box (illustrated in figure 1.0) made of recyclable carton paper with a Fairchild logo printing. One box contains two reels maximum. Certain number of these boxes are placed inside shipping box which comes in different sizes depending on the number of parts shipped.





DO-214AC(SMA) unit orientation

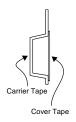
DO-214AC(SMA) Packaging Information							
Packaging Option	Under package code P5	Under package code MA					
Packaging type	TNR	TNR					
Qty per Reel/Tube/Bag	7,500	5,000					
Reel Size (inch diameter)	13	13					
Box Dimension (mm)	336X336X38	340X350X340					
Max qty per Box	15,000	10,000					
Weight per unit (gm)	0.064	0.064					
Weight per Reel (kg)	0.860	0.750					
Note/Comments	Human readable label	Barcode label					

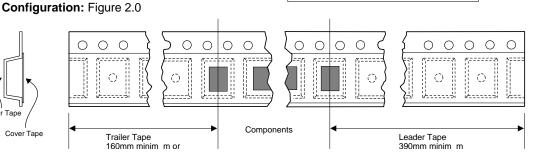


Human Readable Label sample



DO-214AC(SMA) Tape Leader and Trailer

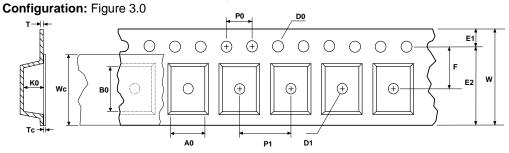




D/C1: T0012 OTY1: SPEC REV:
D/C2: QTY2: CPN:
FAIRCHILD SEMICONDUCTOR INTERNATIONAL (F63TNR)3.2



DO-214AC(SMA) Embossed Carrier Tape



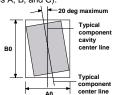


	Dimensions are in millimeter													
Pkg type	A0	В0	w	D0	D1	E1	E2	F	P1	P0	КО	т	Wc	Тс
DO-214AC(SMA) (12mm)	2.72 +/-0.10	5.25 +/-0.10	12.0 +/-0.3	1.55 +/-0.05	1.125 +/-0.125	1.75 +/-0.10	10.25 min	5.5 +/-0.05	4.0 +/-0.1	4.0 +/-0.1	2.45 +/-0.10	0.23 +/-0.10	9.3 +/-0.025	0.06 +/-0.02

Notes: A0, B0, and K0 dimensions are determined with respect to the EIA/Jedec RS-481 rotational and lateral movement requirements (see sketches A, B, and C).



Sketch A (Side or Front Sectional View)
Component Rotation



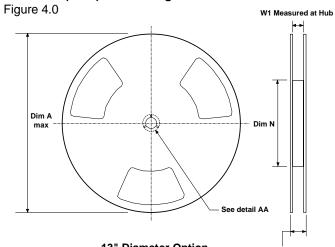
Sketch B (Top View)

Component Rotation



Sketch C (Top View)
Component lateral movement

DO-214AC(SMA) Reel Configuration:



13" Diameter Option	W2 max Mea	sured at Hub

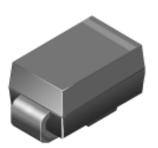
Dim C Dim D **DETAIL AA**

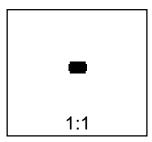
Dimensions are in inches and millimeters								
Tape Size	Reel Option							Dim W2
12mm	13" Dia	13.0 330	0.059 1.5	512 +0.020/-0.008 13 +0.5/-0.2	0.795 20.2	1.97 50 min	0.331 +0.059/-0.000 8.4 +1.5/0	0.567 14.4

DO-214AC(SMA) Package Dimensions



DO-214AC(SMA) (FS PKG Code P5)

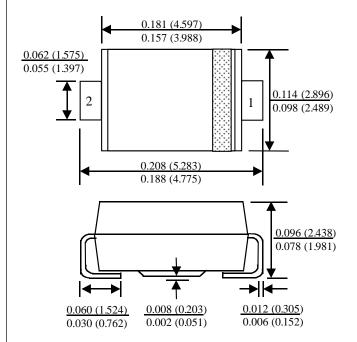


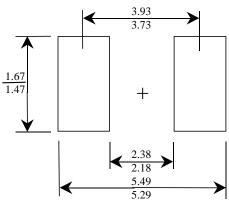


Scale 1:1 on letter size paper

Dimensions shown below are in: inches [millimeters]

Part Weight per unit (gram): 0.064





Minimum Recommended Land Pattern

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DOME™ ISOPLANAR™ Quiet Series™

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